

PID summary

J. Va'vra, SLAC

Talks

- **FDIRC:**

- **J. Va'vra:** FDIRC status - Towards TDR
- **Massimo Benettoni:** FDIRC mechanics, design and modeling
- **Douglas Roberts:** Barrel MC simulation status
- **Christophe Beigbender:** FEE architecture - update on the SNATS chip
- **Vanessa Tocut & Herve Lebbolo:** Front End chip

- **Forward PID:**

- **Jihame Maalmi:** Evaluation of waveform digitizing electronics “WaveCatcher”
- **Leonid Burmistrov:** Simulation of DIRC-like TOF detector
- **Ganna Dolinska:** K/π separation with DIRC-like TOF
- **Eugeniy Kravchenko:** FARICH cost optimization
- **J. Va'vra:** Simplified tile TOF ?

Barrel FDIRC

Bottom line:

- a good progress on design, simulation, mechanics, electronics
- see a light at the end of tunnel in terms of a real practical solution
- manpower very limited

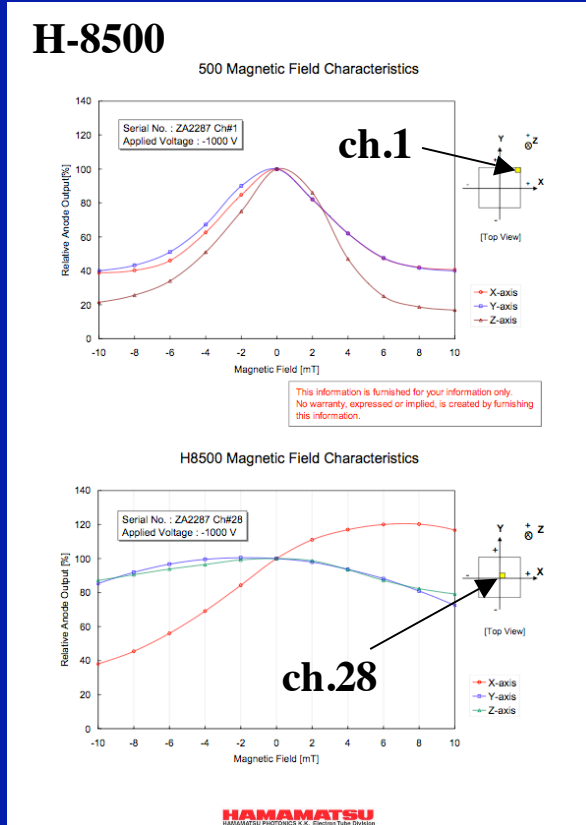
FDIRC: R&D issues to be decided for TDR

J. Va'vra

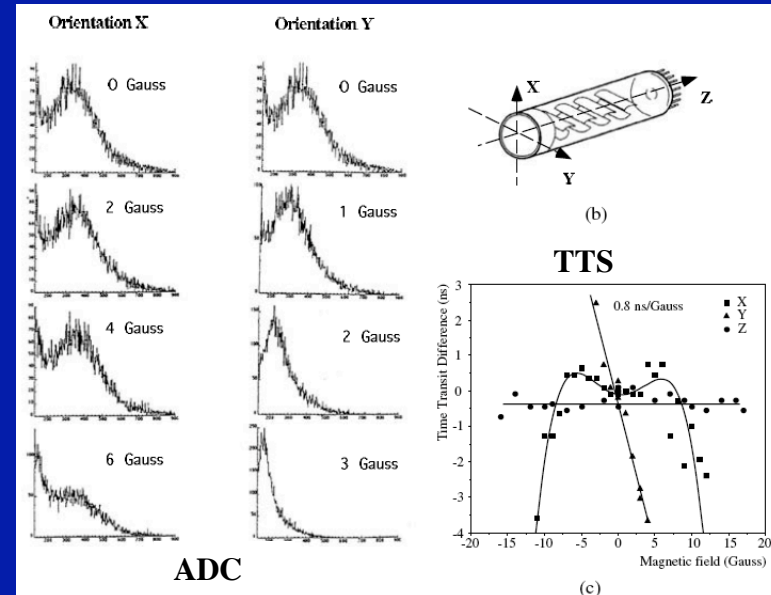
- **Tweak camera optics ?**
- **MC simulation**
- **Micro-wedge ?**
- **Photodetector choice**
- **Magnetic shielding**
- **Electronics concept**
- **Photodetector holder**
- **Laser Calibration Concept**
- **Mechanical design of the new camera**
- **D&D**
- **Real engineering budget.**
- **Background** (Riccardo Cenci: ~150kHz/6x12mm pixel with shielding & ~800kHz without shielding)
- **Due to limited manpower, not included: scanning of MaPMTs, rate and aging studies of MaPMTs, beam tests (all tests will be in CRT), etc.**

H-8500 sensitivity to magnetic field

J. Va'vra



DIRC tube (from NIM paper):



- **DIRC PMT tube was much more sensitive to magnetic field (~1 Gauss is a very visible effect).**
- **H-8500: edge pixels are more sensitive than center pixels:**
up to ~20% amplitude loss at ~20 Gauss; up to ~60% amplitude loss at ~50 Gauss
- **We will need a magnetic shield, but it may not need to be as massive as in BaBar.**
- **We may be able to tolerate a field up to ~10 Gauss, so we may have gained a factor of ~10x.**

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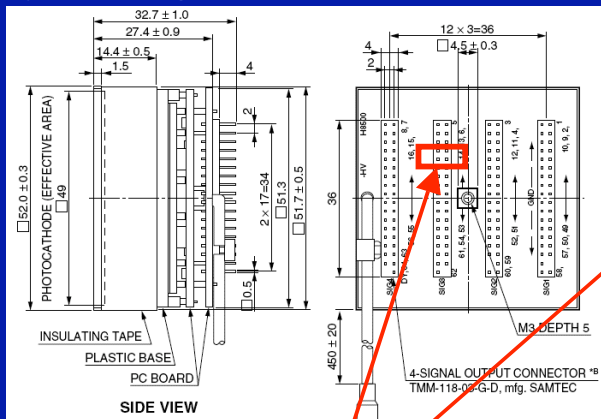
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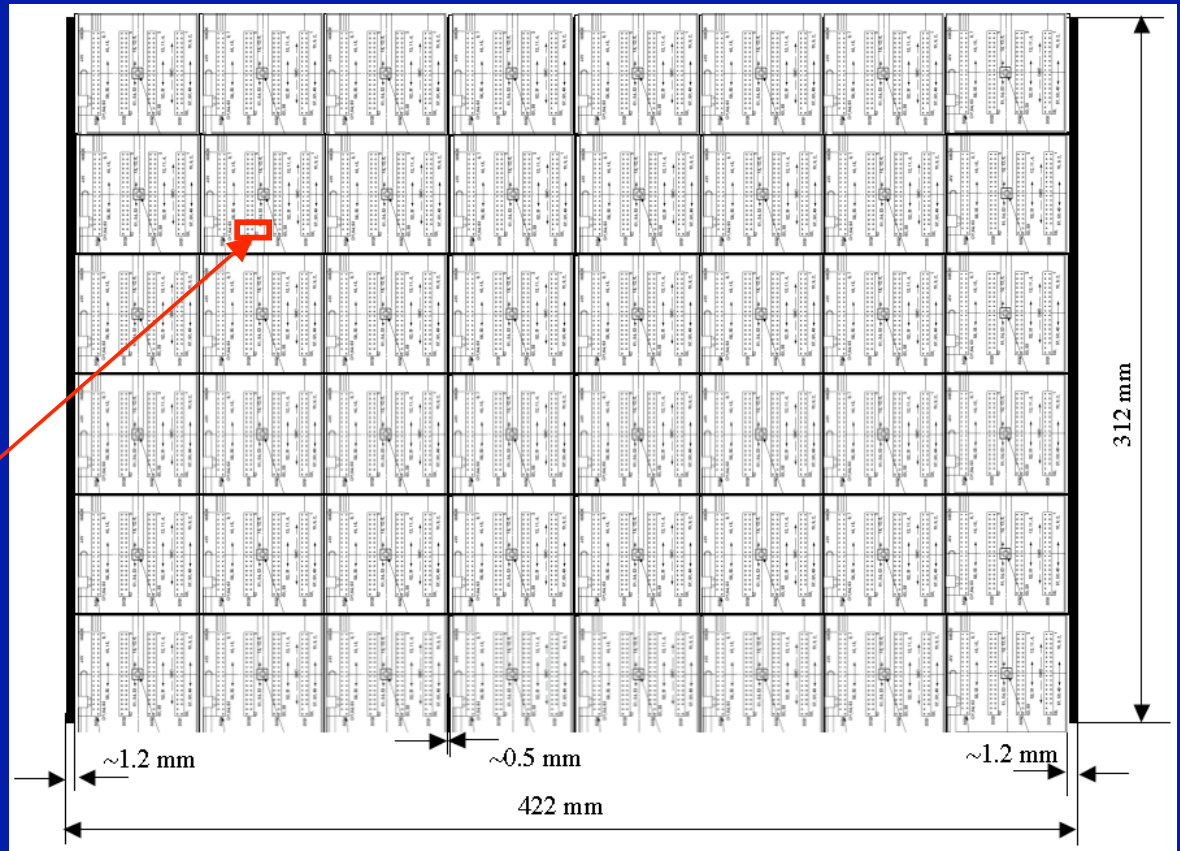
Detector matrix in one camera

J. Va'vra

Detector precision is determined by a holding screw (H-8500):



Shorting of two pads



- Number of H-8500 detectors: $48 = 8 \times 6$ per camera
- Total number of detectors: $576 = 48 \times 12$ per entire system
- Total number of pixels (H-8500): $18,432 = 12 \times 48 \times 32$ per entire system
- If we short two neighboring pads, it has to be done via equal delay path.
- Detectors must be oriented right way for shorting of pads to work properly.
- Doug Roberts: Should we stagger columns by 2-3 mm to avoid possible cracks between MaPMTs ?

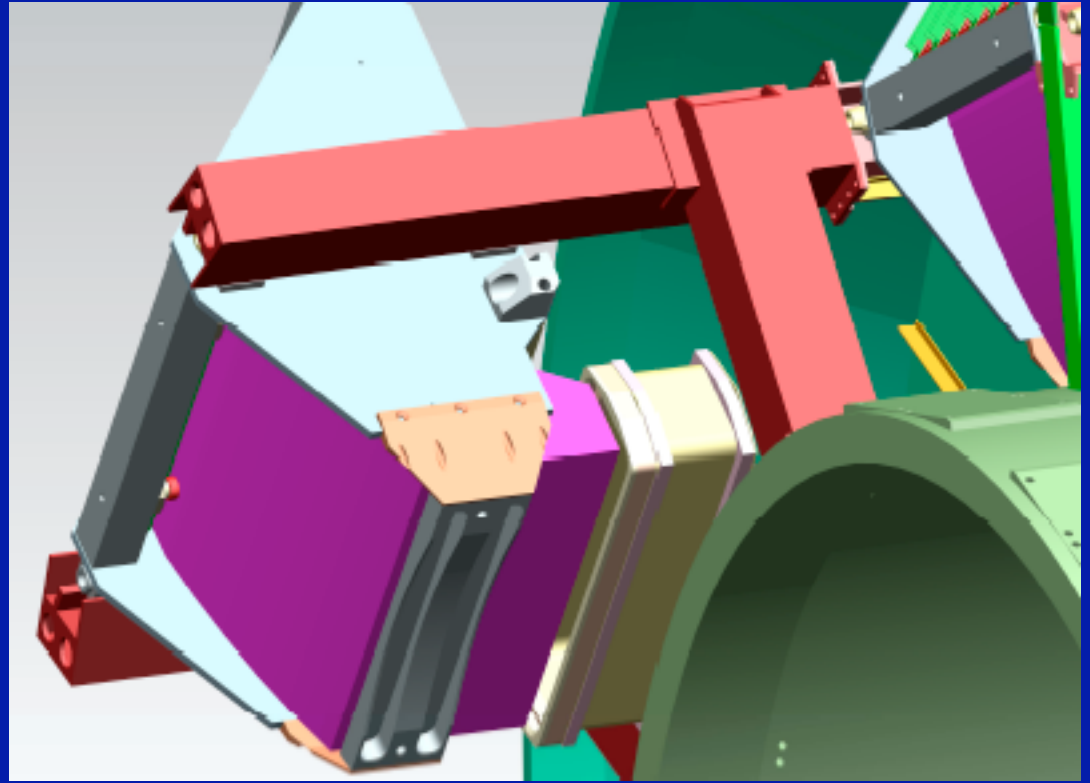
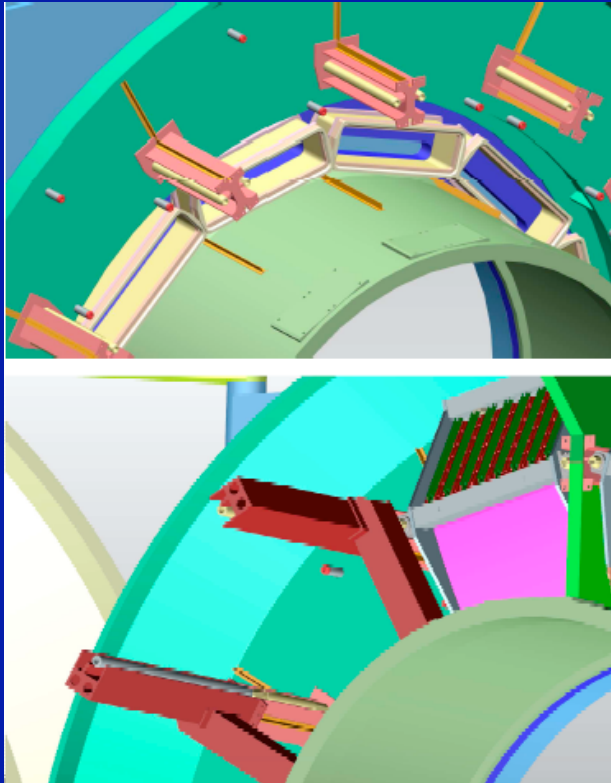
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Mechanical design: putting it all together

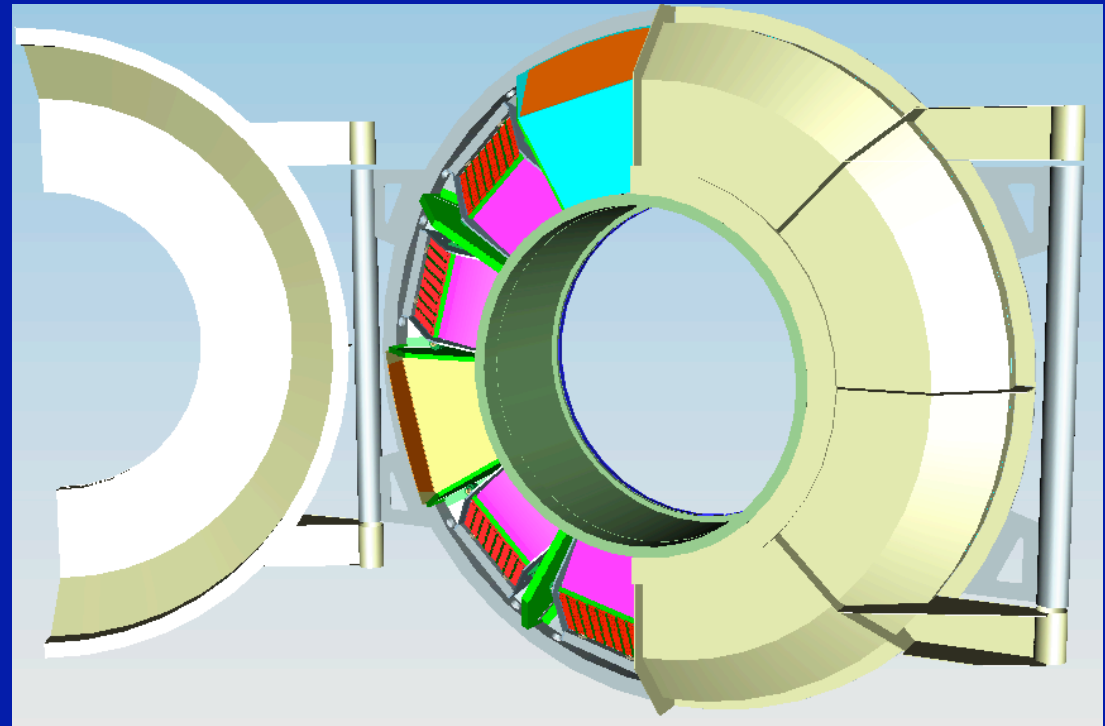
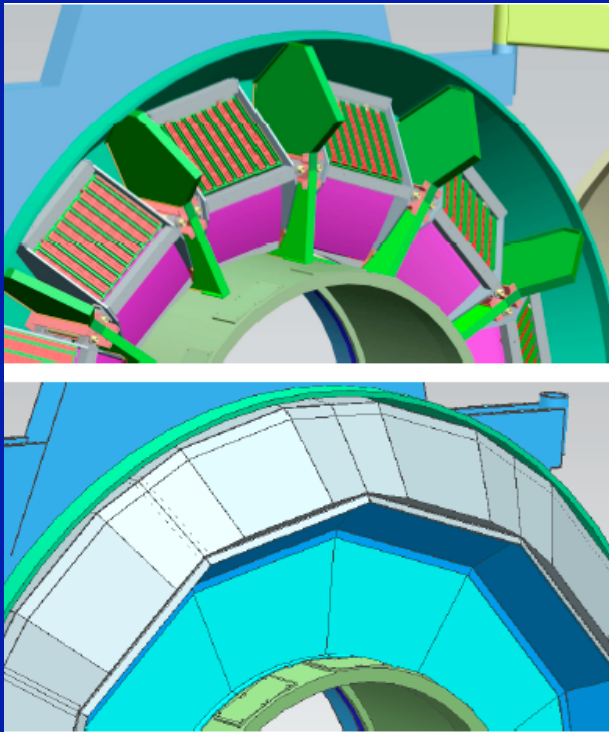
Massimo Benettoni



- **Rail structure enabling the RTV gluing of FBLOCK to bar box some distance away, where we have access. Once that is done, FBLOCK will be pushed into proper z-position.**
- **A viewer available: I can make the same pictures ~5,000 miles away**

Mechanical design: light sealing, access

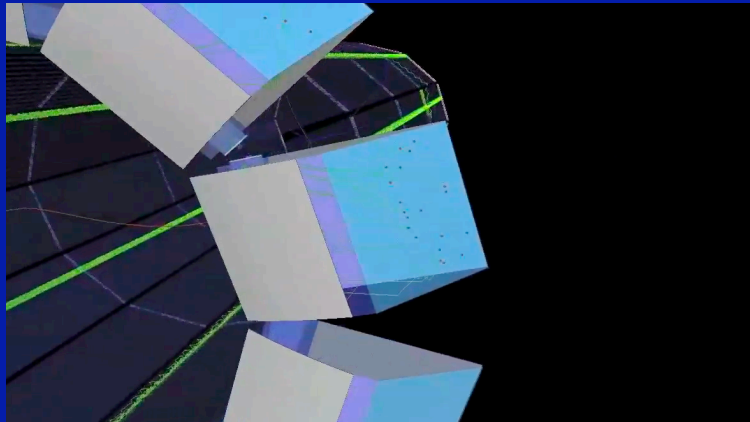
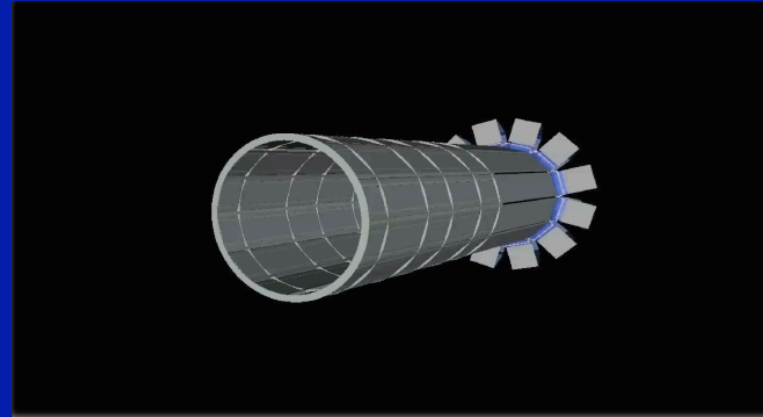
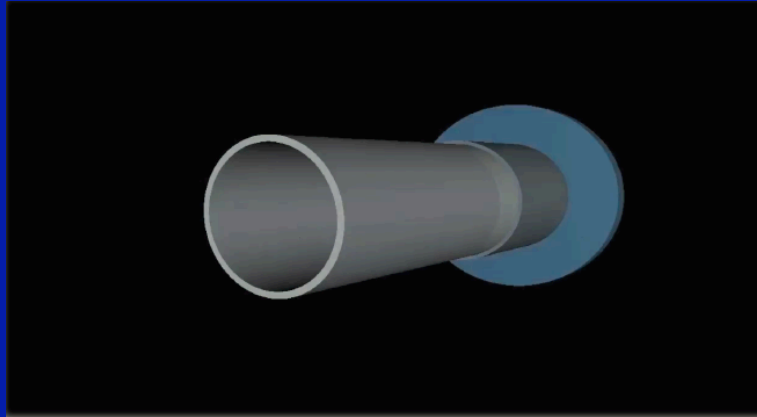
Massimo Benettoni



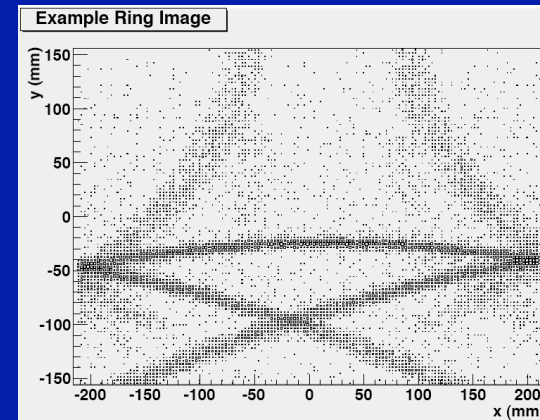
- **Light sealing must be simple to allow easy access to the electronics.**
- **Magnetic door may be smaller than what we have in BaBar. On the other hand, the BaBar door would work and it exists !**

FDIRC in FullSim

Doug Roberts



Ring image at 4 GeV/c with 3mm x 3mm pixels



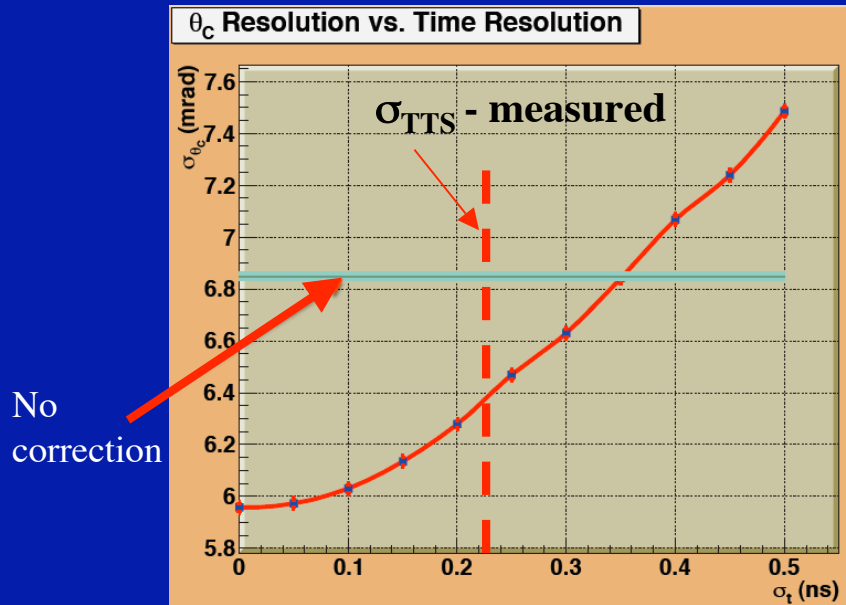
- Very impressive work !!

FDIRC MC simulation: chromatic corrections

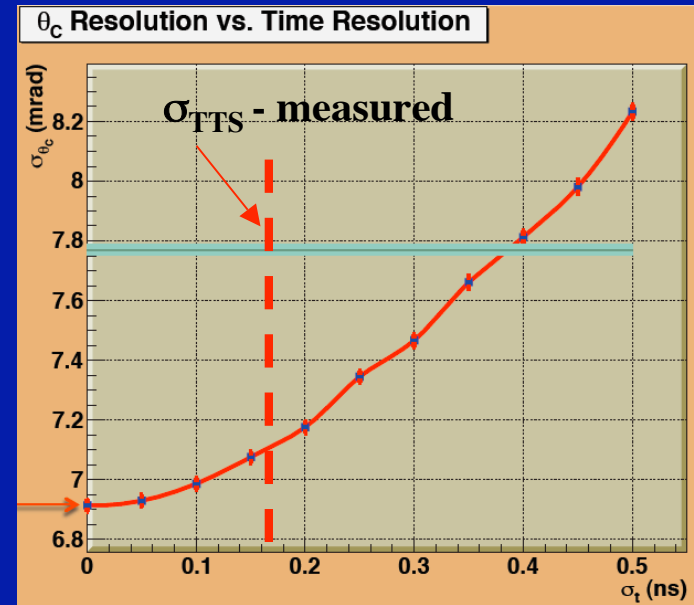
Doug Roberts

Solution with the micro-wedge in:

3mm x 12mm pixels (H-9500):



6mm x 12mm pixels (H-8500):

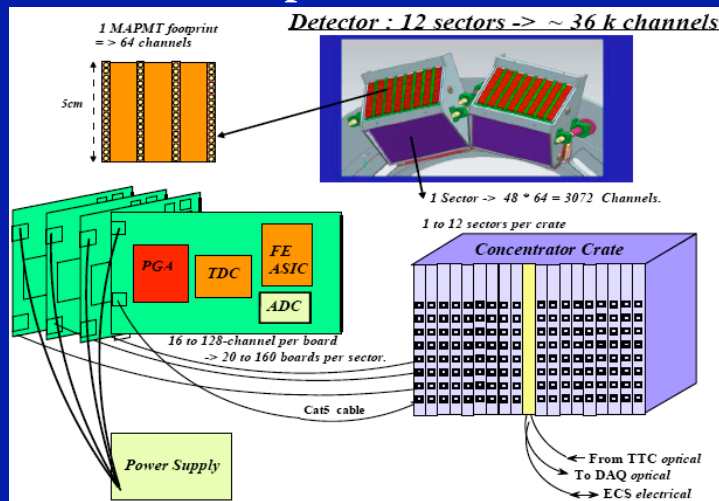


- Results consistent with the FDIRC prototype beam test results.
- Could gain more than ~ 0.5 mrad in θ_c resolution.
- Added JV's lab measurements of the TTS resolution with the two tubes.

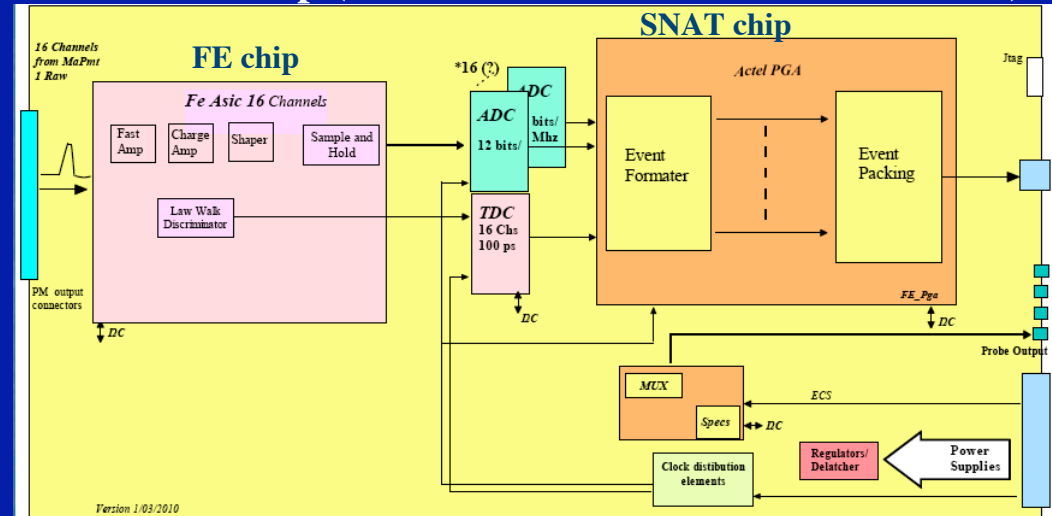
FDIRC TDC/ADC electronics

Christophe Beigbeder

Overall concept:



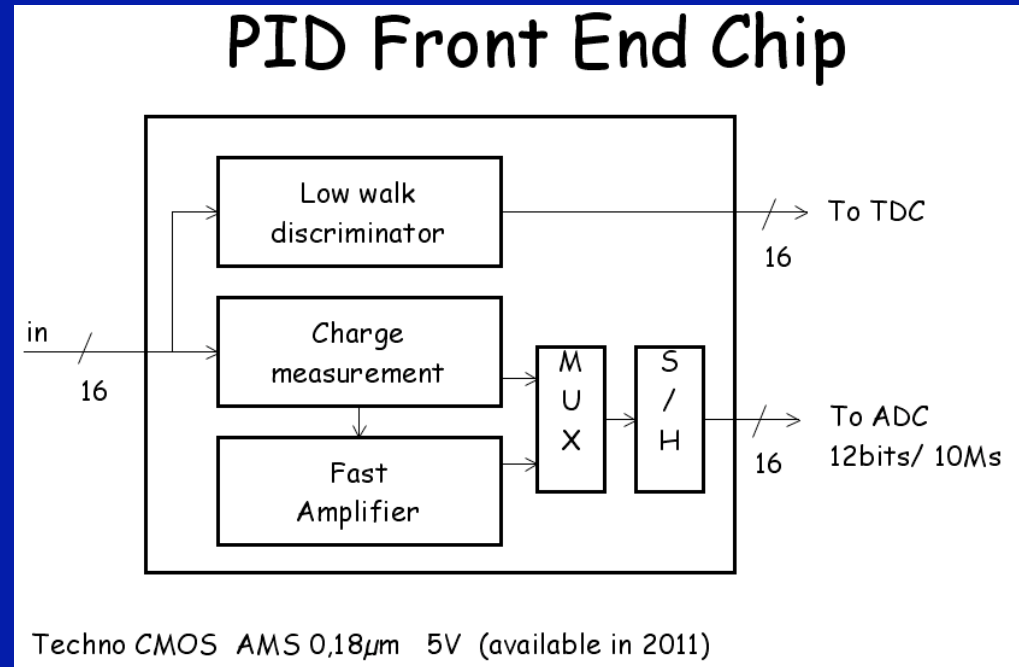
16-channel chip (takes care of one MaPMT connector):



- **FDIRC electronics is split in two parts:**
 - one directly mounted on the PMT receiving signals and processing it with TDC/ADC
 - the other one concentrates and pack all the channels to send data to the DAQ
- **Issues to solve:**
 - chip design, mechanical packaging on the detector, cooling (water or air ?) , etc.
- **Max rate capability: ~2.5 MHz/pixel**
- **Double hit resolving time: ~ 50 ns**
- **SuperB version of two chips availability: first quarter 2011.**
- **CRT test will be done with already existing earlier version, which is available now.**

FDIRC Front end electronics

Vanessa Tocut & Herve Lebbolo



- **Low walk discriminator**
< 70ps
- **Time-to-Digital Convertor**
1sb 200ps
100ps resolution
- **Charge measurement**
- **Great idea: Add a waveform digitization inside the chip to be able to select a random channel by software !!! This is for diagnostic purposes.**
- **0.18 μ m Techno only available by the end of 2010 at MPC.**
- **1st proto submitted by the end of 2011.**

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Forward PID

Bottom line:

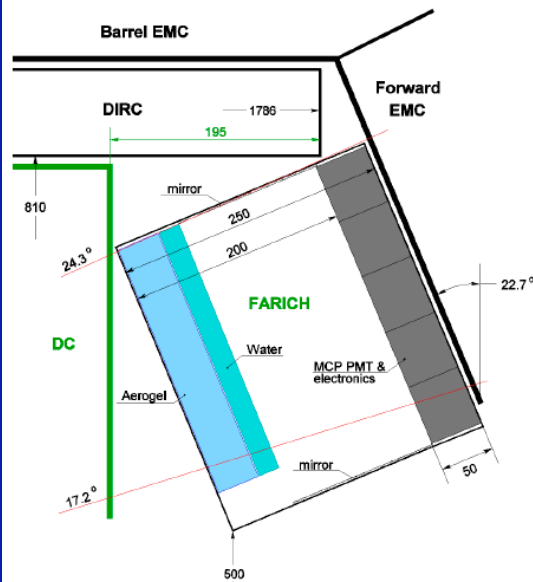
- We do not have yet a solution at hand, which would clearly satisfy a coincidence:
Low cost * Robustness ($N_{pe} \geq 10$) * Background resistance
- People are working very hard to make progress on these issues.
- We should not forget that this device covers only 5-10% of solid angle.
- Manpower is very limited.

FARICH - cost saving proposal

E. Kravchenko

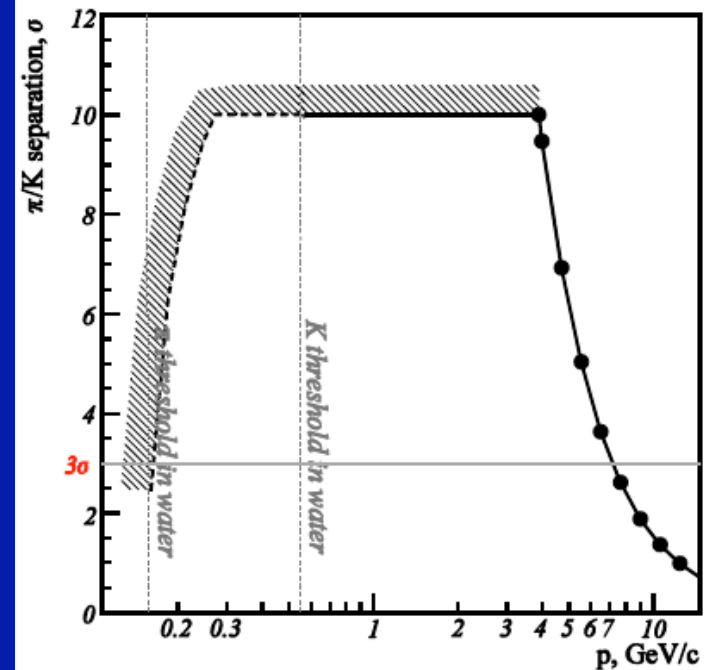
Original proposal:

FARICH with 3 mm pixels



- Expansion gap 200 mm
- Buble MCP PMT with 3.2x3.2 mm pixels (16x16 matrix), photoelectron collection efficiency 70%, geometrical factor 85%
- 3-layer focusing aerogel, $n_{\max}=1.07$, total thickness 30 mm
- Number of PMTs ~ 450
- Number of channels ~ 115000
- Amount of material, (X_0) = 3.5%(aerogel)+ 2.5%(water)+ 14%(MCP PMT)+8% (support, electronics, cables) ~ 28%

Performance with 6mm pixels:



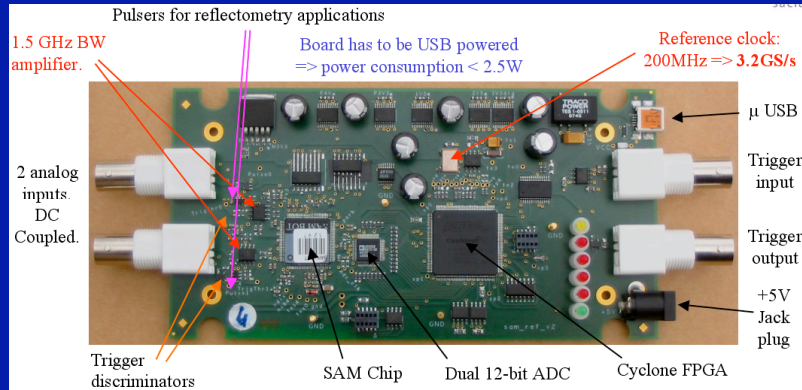
Presented cost saving proposal:

- increase the pixel size from 3mm to 6mm => FARICH will have **28,800 pixels**
- **Preparing a prototype for the beam test.**

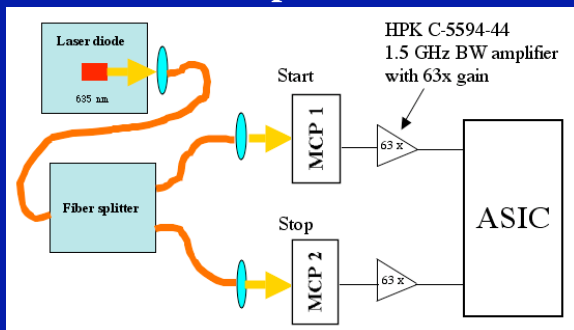
WaveCatcher chip evaluation

Jihane Maalmi

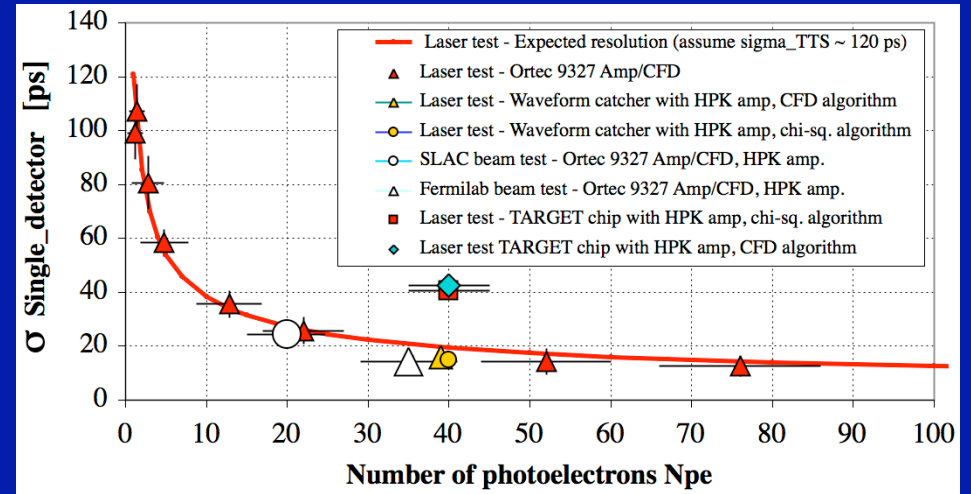
WaveCatcher 2-channel board (3.3GSa/s):



Laser test setup:

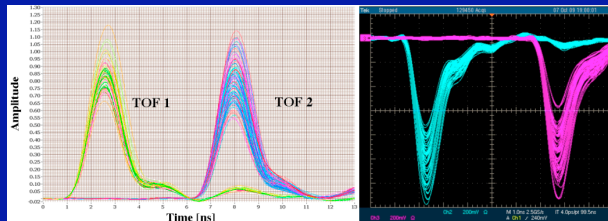


Comparison of various electronics schemes:



WaveCatcher pulses:

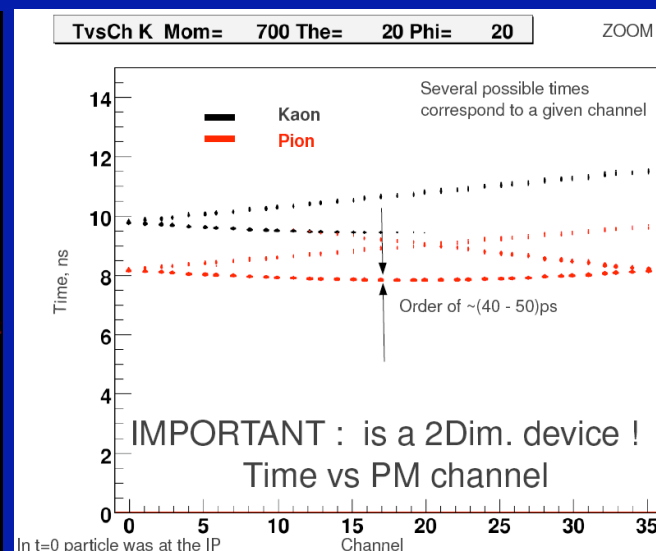
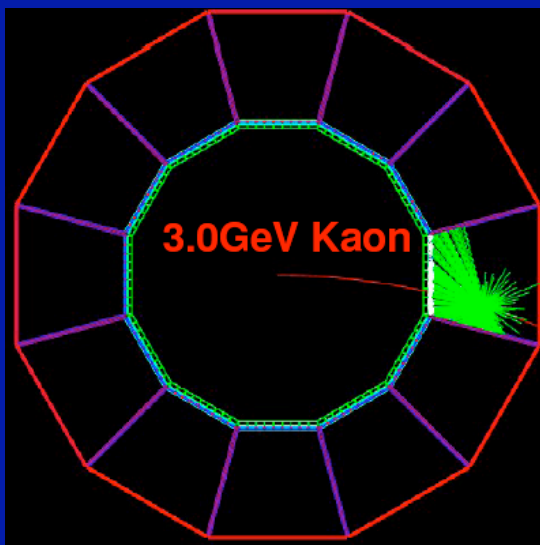
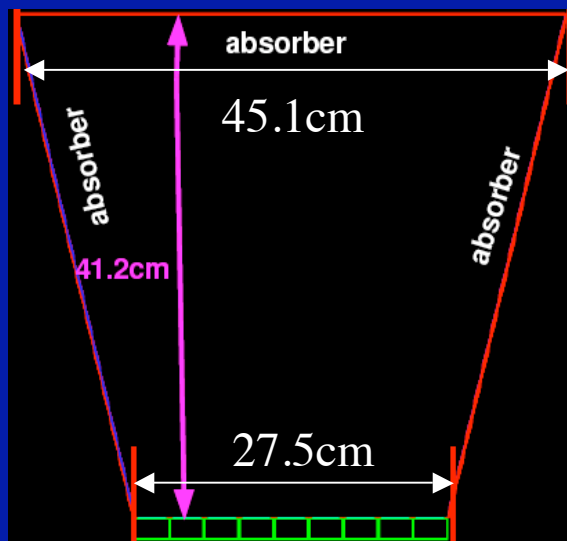
Scope:



- Evaluate the chip in the test setup used for pixilated TOF tests, mainly because we had a lot of previous measurements for comparison.
- WaveCatcher came up as a real winner.
- It will be the electronics used in many experiments in future.
- Could be used for either TOF or cluster counting applications.
- Writing a NIM paper on overall comparison.

DIRC-like TOF Geant4 study: geometry

Leonid Burmistrov



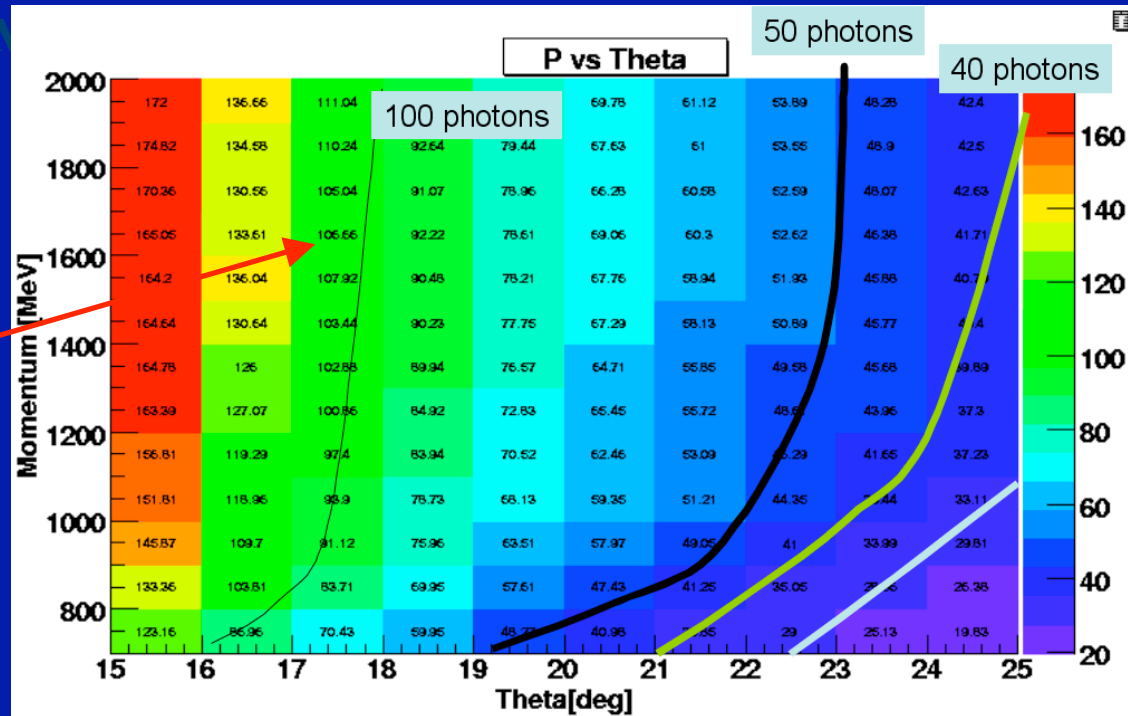
- **Magnetic field: 1.5 Tesla.**
- **Hamamatsu MCP-PMT SL-10 pixel size: 22mm x 5.5mm**
- **12 quartz sectors, 9 MCP-PMTs/sector => 36 pixels per sector**
- **Quartz tile thickness in the simulation so far: 1.2 cm**
- **Quartz tilt angle: $\sim 5^\circ$ => need ~ 5 cm extra space**
- **Not yet in the simulation: realistic background.**
- **Variables to tune to increase Npe: (a) tilt angle, (b) tile thickness (1.2cm -> 2.4cm ?), (c) photon absorber around the tile edges, (d) QE tuning (bialkali vs. GaAsP vs. multi-alkali photocathode), put detectors on both inside & outside diameter, etc.**

DIRC-like TOF MC study: N_{pe}

Leonid Burmistrov

5° tilt angle:

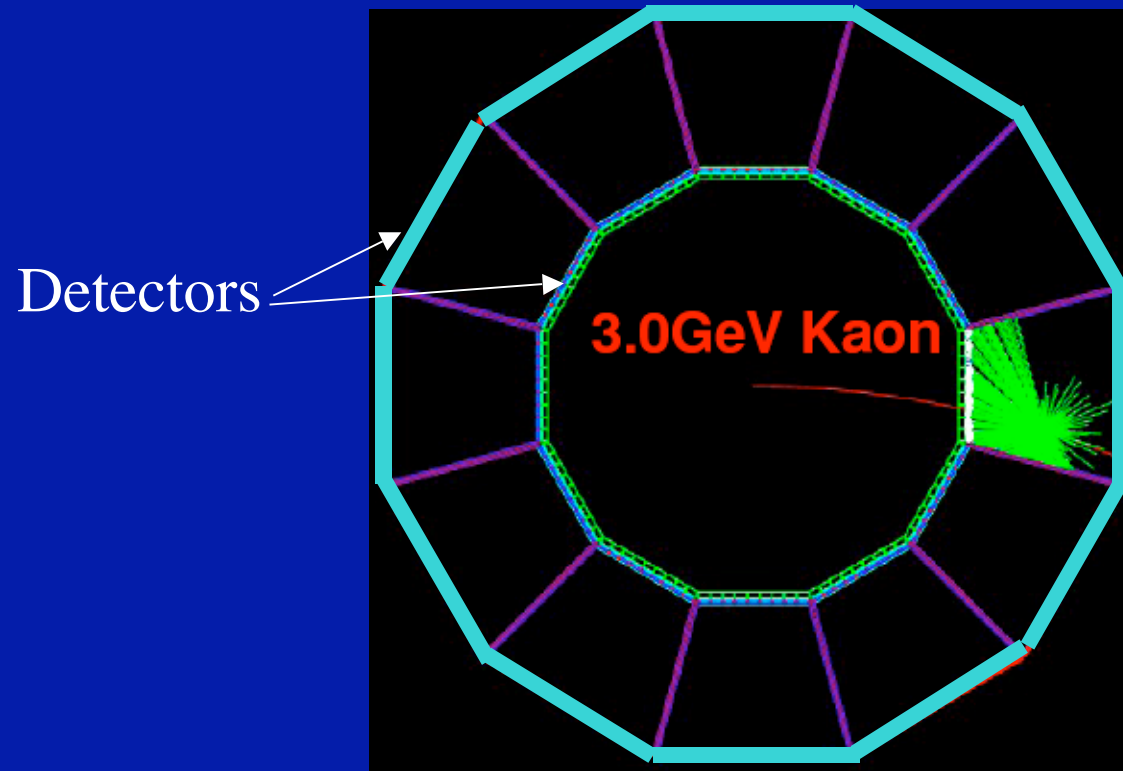
N_{photons}
(not N_{pe} !!!)



- In some section of the phase space one deals with 3 photoelectrons only - that is clearly too low. The only variables one has to tweak: the radiator thickness, its tilt, or add more detectors at outer radius.
- Comment on the SL-10 MCP-PMT efficiency:
 1. QE for multi-alkali photocathode at 350nm: ~20%
 2. Geometrical collection efficiency of the 1-st MCP for in-time photoelectrons: 70%
 3. Dead space between boundaries: 65%
 => Therefore the total fraction of in-time photons detected (a product of all above numbers): **PDE ~9%**.

Suggestion for possible increase of Npe

J. Va'vra



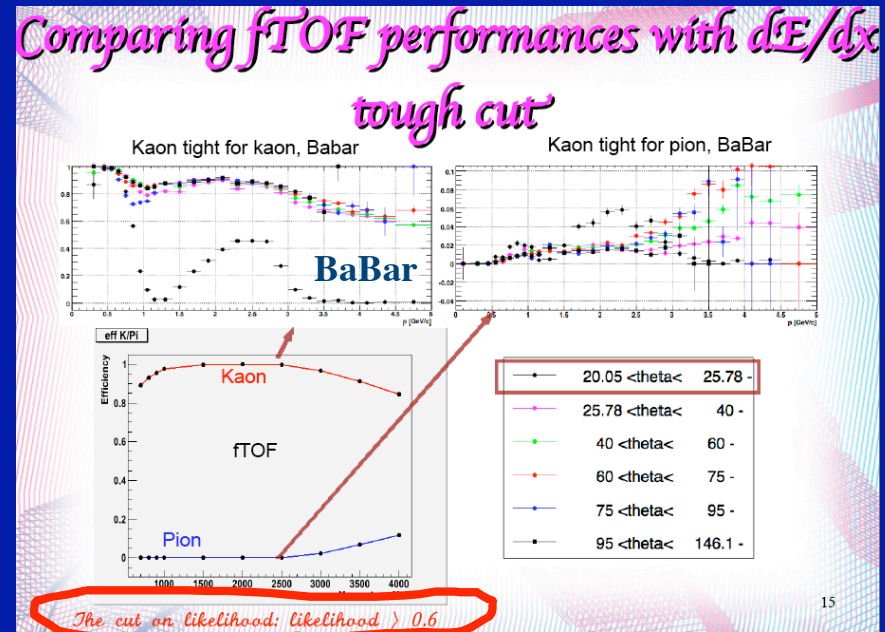
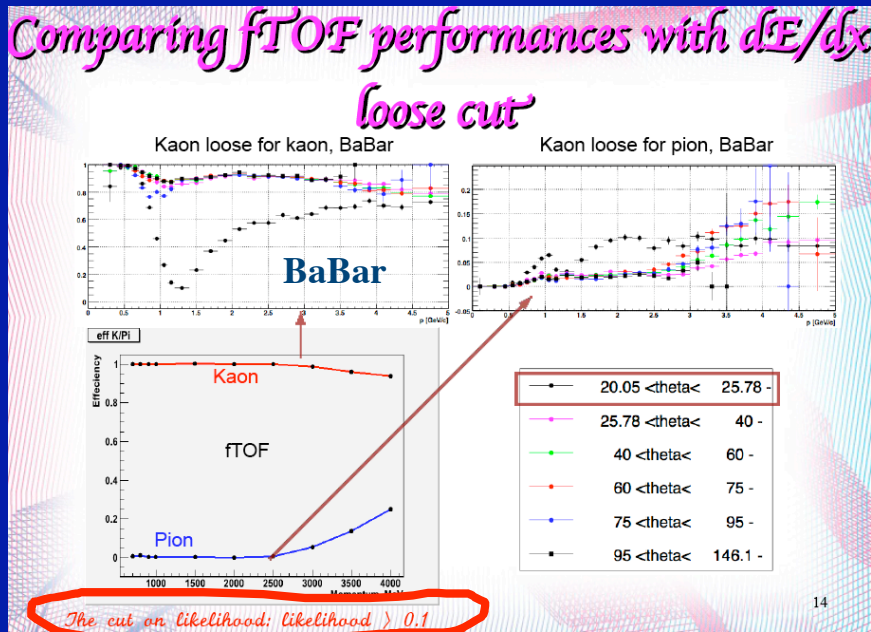
- Put photon detectors on both inner and outer side of quartz plate
- This will increase the cost but one may get into a regime of $N_{pe} > 10$.
- Leonid is now studying this option.
- Other similar options investigated. We think N_{pe} problem can be fixed.

DIRC-like TOF: K/ π separation

Ganna Dolinska

For a design on page 15:

$$Likelihood = \prod e^{(-\chi_i^2)} \quad \chi^2 = \left(\frac{time.measured - expected}{RMS} \right)^2$$



$$Likelihood.ratio = \frac{likelihood(K)}{likelihood(K) + likelihood(\pi)}$$

Likelihood ratio $\rightarrow 1 \rightarrow K$
 Likelihood ratio $\rightarrow 0 \rightarrow \pi$

- **Important point: background not yet included.**

What should be a criteria for minimum requirements on acceptable performance ?

PID group discussion during the session

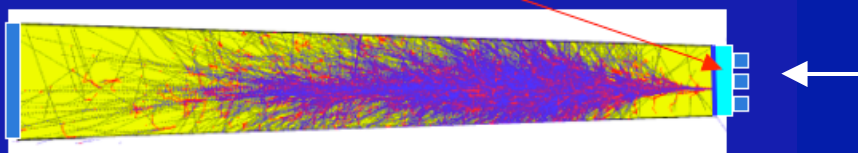
- A design with $N_{pe} \sim 3$ is not good enough.
- A minimum of $N_{pe} \geq 10$ should be considered a “robust performance” (in principle $N_{pe} \sim 5$ might be good enough, but if the aging effects cause a slow degradation, one may end up with $N_{pe} \sim 3$).
- Background must be understood much more than presently. It might be difficult to understand neutrons at the end, but we should make sure that Bhabhas alone will not kill the detector’s performance).
- Detector rate and aging effects must be understood.
- Cost should scale with the solid angle fraction.
- Not everything can be simulated. One needs measurements as well.
- **Most of these issues will be addressed by the time of Elba meeting.**

A simple pixilated TOF ?

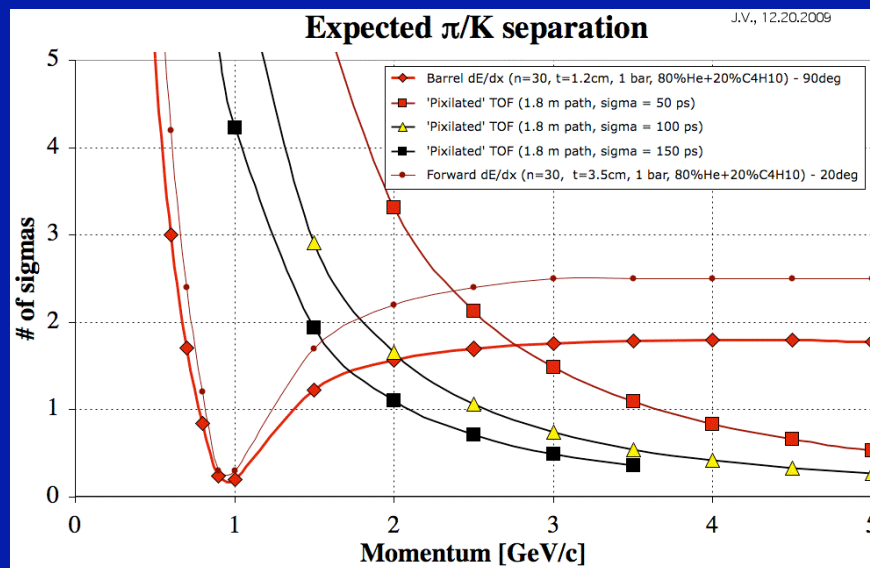
J. Va'vra

Forward region:

Add a 1cm-long **fast scintillator**, add 4 G-APDs to front,
Increase the light amount by adding a mirror



Works with a scintillation light from fast scint.



- **Logic of this counter:** (a) must be cheap, (b) fill up the dE/dx hole near 1 GeV/c for K/ π separation, and (c) $\sigma \sim 100-150$ ps resolution .
- Initial tests with LYSO crystal started. Likely to switch to a fast scintillator.
- Looking into some clever way to read out the scintillator tile with limited number of G-APDs.
- 1 pixel = 1 LYSO crystal footprint
- Electronics: could we use FDIRC TDC/ADC chip serving 16 LYSO crystal footprints ?
- Pulse height to be added to the EMC calorimeter pulse height.

We were encouraged to make a decision within 6 months.